#### TOSHIBA PHOTOCOUPLER PHOTO RELAY

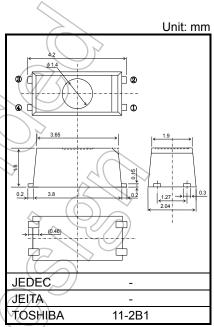
# **TLP3214**

Measuring Instruments Logic IC Testers / Memory Testers **Board Testers / Scanners** 

The TOSHIBA TLP3214 is an ultra-small photorelay suitable for surfacemount assembly. The TLP3214 consists of an infrared emitting diode optically coupled to a photo-MOSFET and is housed in a 4-pin package. Its features include low Off-state current and low output pin capacitance, enabling it to be used for high-frequency measuring instrument applications.

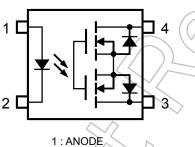
#### **Features**

- 4-pin SSOP (SSOP4): 1.8 mm high, 1.27 mm pitch
- 1-Form-A
- Peak Off-State Voltage: 40 V (min)
- Trigger LED Current: 4 mA (max)
- On-State Current: 250 mA (max)
- On-State Resistance: 3  $\Omega$  (max), 2  $\Omega$  (typ.)
- Output Capacitance: 7 pF (max), 5 pF (typ.)
- Isolation Voltage: 1500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349



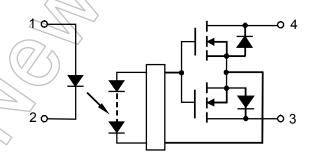
Weight: 0.03 g (typ.)

#### **Pin Configuration (Top View)**



- 2: CATHODE
- 3: DRAIN
- 4: DRAIN

## **Schematic**



Start of commercial production 2002-09

#### Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT	
	Forward Current	lF	50	mA	
	Forward Current Derating (Ta ≥ 25°C)	ΔI <sub>F</sub> /°C	-0.5	mA/°C	
۵	Reverse Voltage	V <sub>R</sub>	5	V	
핃	Diode Power Dissipation	$P_D$	50	mVV	
	Diode Power Dissipation Derating (Ta ≥ 25°C)	ΔP <sub>D</sub> /°C	-0.5	mW/°C	
	Junction Temperature	Tj	125	°C	
	Off-State Output Terminal Voltage	Voff	40	(V)/	
<u>~</u>	On-State Current	Ion	250	mA	
CTO	On-State Current Derating (Ta ≥ 25°C)	Δlon/°C	-2.5	mA/°C	
DETECTOR	Output Power Dissipation	Po	188	mW	
□	Output Power Dissipation Derating (Ta ≥ 25°C)	ΔP <sub>o</sub> /°C	-1.88	mW / °C	
	Junction Temperature	Tj	125	°C	
Stora	ge Temperature Range	T <sub>stg</sub>	-40 to 125	°C	
Opera	ating Temperature Range	Topr	-20 to 85	© \	
Lead	Soldering Temperature (10 s)	T <sub>sol</sub>	260	°C <	
Isolat	ion Voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1)	BVs	1500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device. Pins 1 and 2 shorted together, and pins 3 and 4 shorted together.

#### Caution

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

#### **Recommended Operating Conditions**

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	VDD	> -	_	32	V
Forward Current	/F	_	_	30	mA
On-State Current	ION	_	_	250	mA
Operating Temperature	Topr	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

## Individual Electrical Characteristics (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
	Forward Voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	lR	V <sub>R</sub> = 5 V	_	_	10	μA
	Capacitance	Ст	V = 0 V, f = 1 MHz	1	15	1	pF
DETECTOR	Off-State Current	loff	V <sub>OFF</sub> = 30 V, Ta = 50 °C	ı		1000	pA
DETE	Capacitance	COFF	V = 0 V, f = 100 MHz, t < 1 s	-	5	7	pF

# **Coupled Electrical Characteristics (Ta = 25°C)**

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Trigger LED Current	I <sub>FT</sub>	I <sub>ON</sub> = 100 mA	_	_	4	mA
Return LED Current	I <sub>FC</sub>	I <sub>OFF</sub> = 10 μA	0.2	0.75	_	mA
On-State Resistance	Ron	I <sub>ON</sub> = 250 mA, I <sub>F</sub> = 5 mA, t < 1 s	1	2	3	Ω

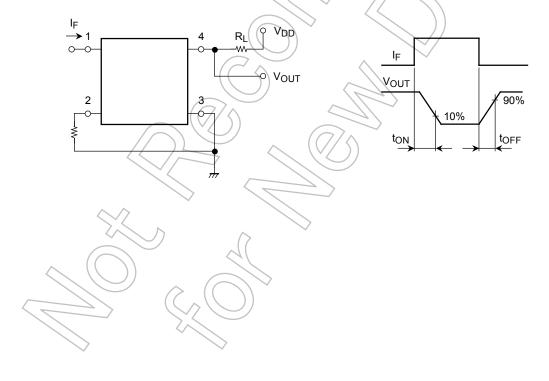
## **Isolation Characteristics (Ta = 25°C)**

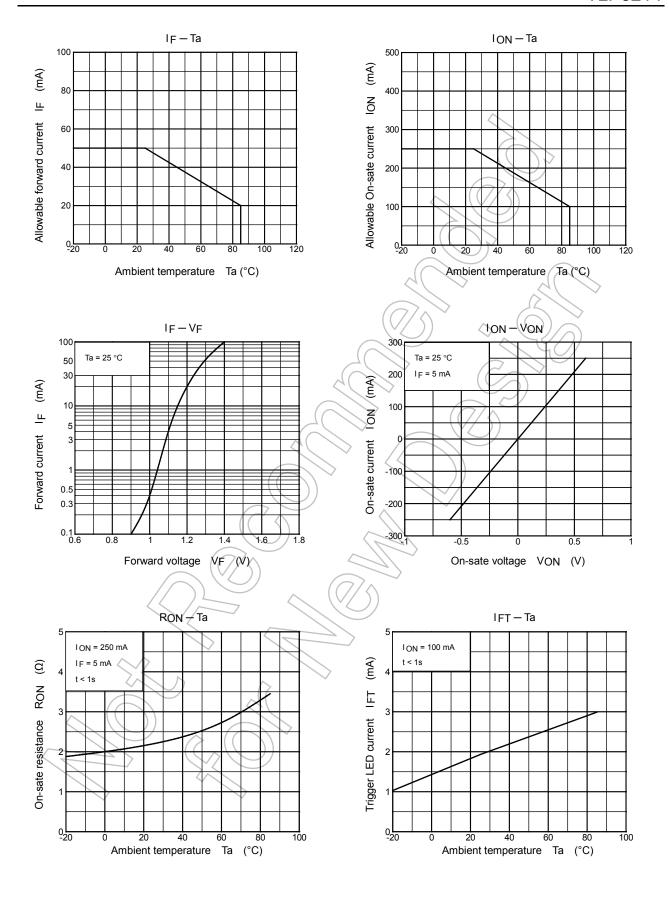
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance Input to Output	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	/ (	0.3	_	pF
Isolation Resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation Voltage	BVs	AC, 60 s	1500	4	4	Vrms

## **Switching Characteristics (Ta = 25°C)**

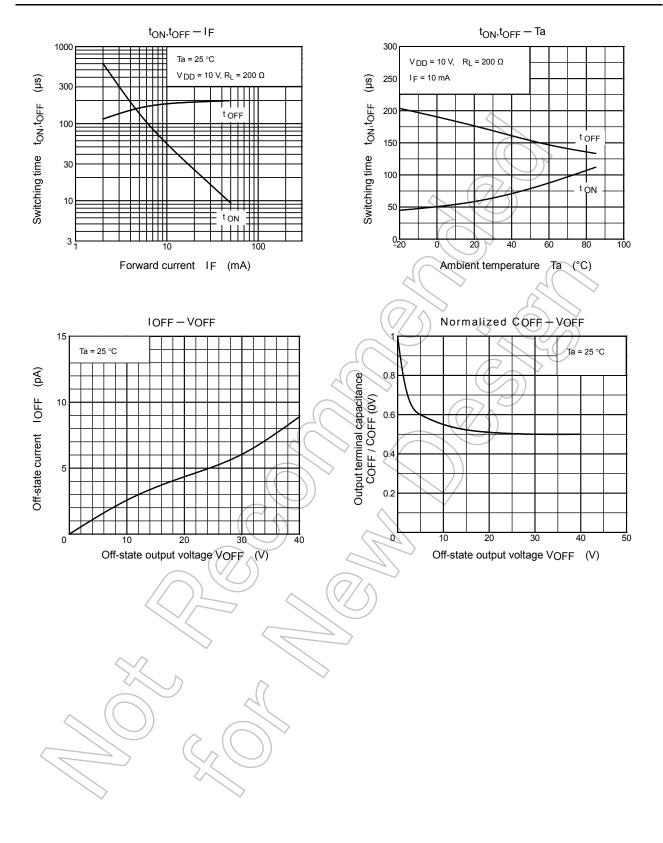
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Turn-on Time	ton	$R_L = 200 \Omega$ (Note 2)		120	500	
Turn-off Time	toff	$V_{DD} = 10 \text{ V, IF} = 5 \text{ mA}$	7/4	140	500	μs

Note 2: SWITCHING TIME TEST CIRCUIT



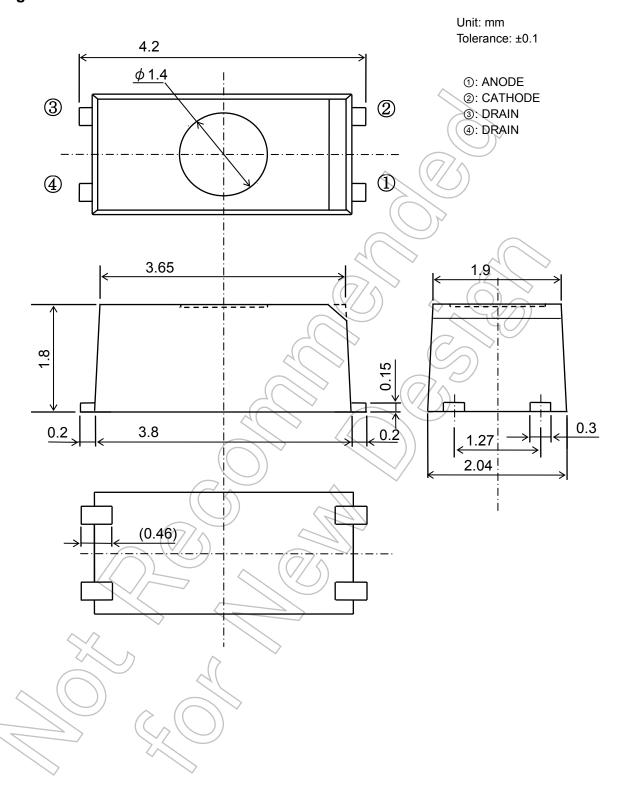


NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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# **Package Dimensions**



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